

E-Bar Oxide Free Extruded Bar Solder

Lead-bearing and Lead-free alloys

Product Description

Complicated electronic assemblies and printed circuit boards require not only conformance to industry material specifications, but also alloys completely free of non-metallic oxides. Kester, in cooperation with the electronics industry, designed and developed Kester E-Bar. It is the answer to thorough metallic continuity, increased fluidity, and reduced surface tension. Electronic assembly engineers, who have depended on Kester for answers to their soldering problems throughout the years, now are assured of the highest quality soldering of printed circuit boards and electronic assemblies.

Maximum Allowed Impurities

Kester E-Bar substantially exceeds the requirements of current industry standards for allowable impurity requirements.

Element	J-STD-006	Kester E-Bar	Kester Ultrapure [®]	Ultra Low Dross	Ultrapure [®] HAL
Copper	0.080	0.020	0.015	0.015	0.001
Gold	0.050	0.002	0.002	0.002	0.001
Antimony	0.050	0.050	0.050	0.050	0.010
Cadmium	0.002	0.001	0.001	0.001	0.001
Zinc	0.003	0.001	0.001	0.001	0.001
Aluminum	0.005	0.002	0.002	0.002	0.001
Iron	0.020	0.010	0.010	0.010	0.003
Arsenic	0.030	0.020	0.020	0.020	0.001
Bismuth	0.100	0.025	0.020	0.020	0.003
Silver	0.100	0.003	0.002	0.002	0.001
Nickel	0.010	0.002	0.002	0.002	0.001
Indium	0.100	0.007	0.007	0.007	0.002
Lead	0.100	0.050	0.050	0.050	0.050

Kester bar solder will conform to these requirements when purchased directly or through stocking distributors. Only the highest purity virgin metals are used to make Kester E-Bar. Kester is the only manufacturer of E-Bar quality solder. Kester E-Bar meets or exceeds Industry Specification ASTM B32. Kester E-Bar conforms to the requirements of J-STD-006 formerly QQ-S-571F. DOD-STD-2000-1A (Soldering Technology, High Quality/High Reliability) states that it is the responsibility of the manufacturer to select those materials and processes that will produce acceptable high quality/high reliability products.

Available Alloys

	Melting Point
Lead-bearing	
Sn63Pb37	183°C (361°F)
Sn60Pb40	183-190°C (361-374°F)
Lead-free	
Sn95Sb05	232-240°C (450-464°F)
Sn96.5Ag3.5	221°C (430°F)
Sn96.5Ag3.0Cu0.5	217-220°C (423-428°F)
Sn95.5Ag3.8Cu0.7	217-221°C (423-430°F)
Sn99.3Cu0.7	227°C (441°F)
Sn100	232°C (450°F)

Storage and Shelf Life:

Kester E-Bar has no limited shelf life when handled properly. Storage must be in a dry, non-corrosive environment. The solder surface may lose its shine and appear a dull shade of gray. This is a surface phenomenon and is not detrimental to product functionality.

Health & Safety:

This product, during handling or use, may be hazardous to health or the environment. Read the Material Safety Data Sheet and warning label before using this product.

World Headquarters: 800 West Thorndale Avenue, Itasca, Illinois, 60143 USA
Phone: (+1) 847-297-1600 • **Email:** customerservice@kester.com • **Website:** www.kester.com

Asia Pacific Headquarters
 500 Chai Chee Lane
 Singapore 469024
 (+65) 6449-1133
 customerservice@kester.com.sg

European Headquarters
 Zum Plom 5
 08541 Neuensalz
 Germany
 (+49) 3741 4233-0
 customerservice@kester-eu.com

Japanese Headquarters
 20-11 Yokokawa 2-Chome
 Sumida-Ku
 Tokyo 130-0003 Japan
 (+81) 3-3624-5351
 jpsales@kester.com.sg

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